

Alpha & Omega Semiconductor Product Reliability Report

AOZ8S315BLS-03, rev A

Plastic Encapsulated Device

ALPHA & OMEGA Semiconductor, Inc

www.aosmd.com

Jul, 2020



This AOS product reliability report summarizes the qualification result for AOZ8S315BLS-03. Accelerated environmental tests are performed on a specific sample size, and then followed by electrical test at end point. Review of final electrical test result confirms that AOZ8S315BLS-03 passes AOS quality and reliability requirements. The released product will be categorized by the process family and be routine monitored for continuously improving the product quality.

Test Item	Test Condition	Time Point	Total Sample Size	Number of Failures	Reference Standard	
HTRB	Temp = 150°C, Vdd=100% of VRWMmax	168 / 500 / 1000 hours	231 pcs	0	JESD22-A108	
Precondition (Note A)	168hr 85°C / 85%RH + 3 cycle reflow@260°C	-	924 pcs	0	JESD22-A113	
HAST	HAST 130°C , 85%RH, 33.3 psia, Vdd = 80% of VRWMmax		231 pcs	0	JESD22-A110	
Autoclave	121°C , 29.7psia, RH=100%	96 hours	231 pcs	0	JESD22-A102	
Temperature Cycle	•		231 pcs	0	JESD22-A104	
HTSL	Temp = 150°C	1000 hours	231 pcs	0	JESD22-A103	

I. Reliability Stress Test Summary and Results

Note: The reliability data presents total of available generic data up to the published date. Note A: MSL (Moisture Sensitivity Level) 1 based on J-STD-020

II. Reliability Evaluation

FIT rate (per billion): 15.26 MTTF = 7480 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

Failure Rate = $Chi^2 x 10^9 / [2 (N) (H) (Af)] = 15.26$ MTTF = $10^9 / FIT = 7480$ years

 Chi^2 = Chi Squared Distribution, determined by the number of failures and confidence interval N = Total Number of units from burn-in tests

H = Duration of burn-in testing

Af = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse = $55^{\circ}C$) Acceleration Factor [**Af**] = **Exp** [Ea / k (1/Tj u - 1/Tj s)]

Acceleration Factor ratio list:											
		55 deg C	70 deg C	85 deg C	100 deg C	115 deg C	130 deg C	150 deg C			
	Af	259	87	32	13	5.64	2.59	1			

Tj s = Stressed junction temperature in degree (Kelvin), K = C+273.16

Tj u =The use junction temperature in degree (Kelvin), K = C+273.16

 \mathbf{k} = Boltzmann's constant, 8.617164 X 10⁻⁵ eV / K